

US00D665519S

(12) **United States Design Patent**
Oyaizu

(10) **Patent No.:** **US D665,519 S**

(45) **Date of Patent:** **** Aug. 14, 2012**

(54) **LIGHT EMITTING DIODE MODULE**

(75) **Inventor:** **Tsuyoshi Oyaizu**, Kanagawa (JP)

(73) **Assignee:** **Toshiba Lighting & Technology Corporation**, Kanagawa (TW)

(**) **Term:** **14 Years**

(21) **Appl. No.:** **29/375,176**

(22) **Filed:** **Sep. 17, 2010**

(30) **Foreign Application Priority Data**

Jun. 22, 2010 (JP) 2010-015236

(51) **LOC (9) Cl.** **26-04**

(52) **U.S. Cl.** **D26/1**

(58) **Field of Classification Search** D26/1-4;
313/313, 315, 316, 317, 318, 493; D13/180-182;
362/555, 800, 309

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

D528,672 S * 9/2006 Nagai et al. D26/1
D570,506 S * 6/2008 Uemoto et al. D26/24

D573,731 S * 7/2008 Uemoto et al. D26/24
D636,899 S * 4/2011 Shibahara D26/1
D658,601 S * 5/2012 Egawa et al. D13/180
D658,603 S * 5/2012 Egawa et al. D13/180

FOREIGN PATENT DOCUMENTS

JP D1183708 9/2003
JP D1218688 9/2004
JP D1343584 11/2008

* cited by examiner

Primary Examiner — Marcus Jackson

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(57) **CLAIM**

The ornamental design for a light emitting diode module, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a light emitting diode module showing my new design;

FIG. 2 is a front view thereof;

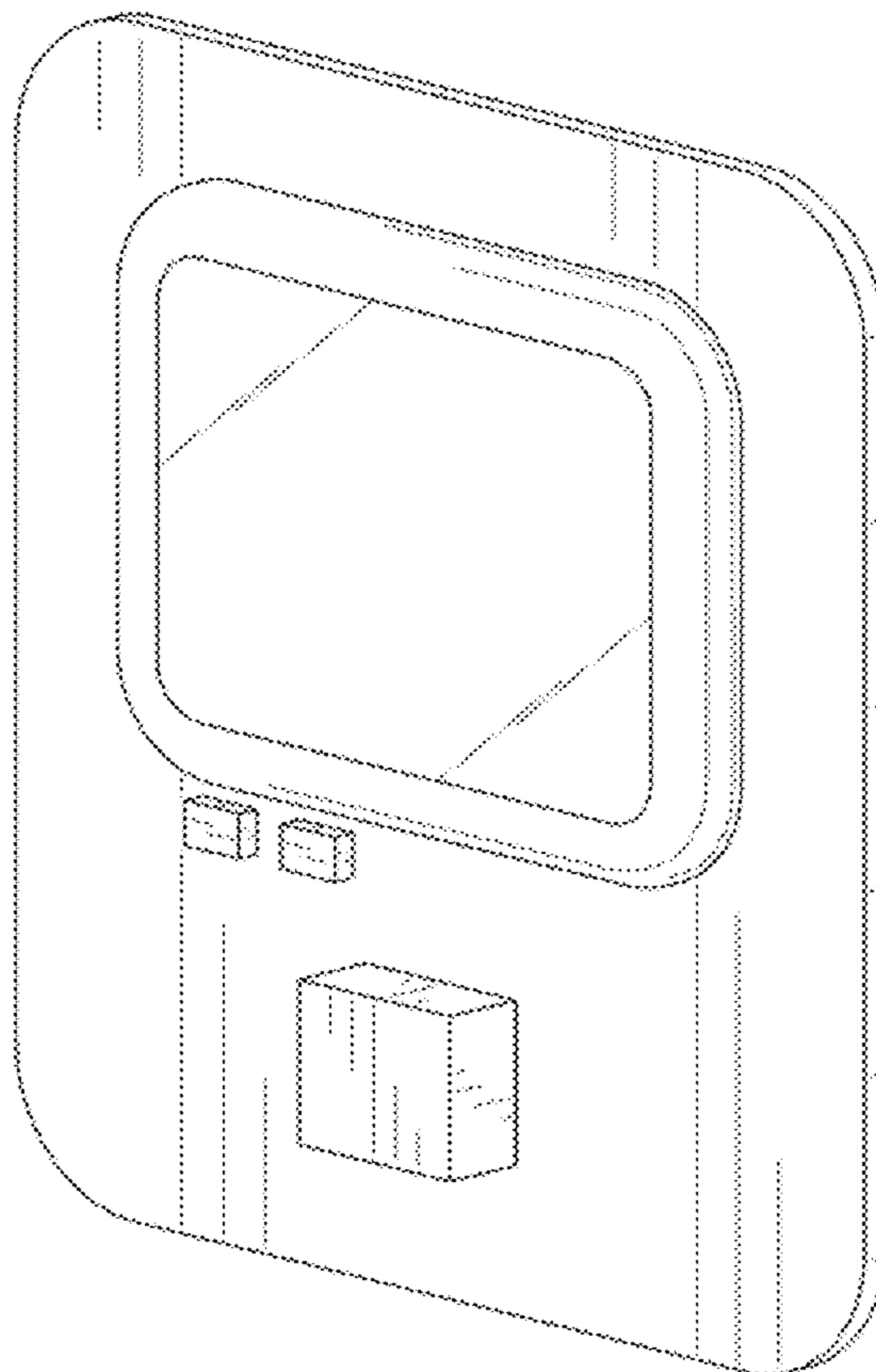
FIG. 3 is a rear view thereof;

FIG. 4 is a right side view thereof, the left side view being a mirror image of the right side view;

FIG. 5 is a top view thereof; and,

FIG. 6 is a bottom view thereof.

1 Claim, 5 Drawing Sheets



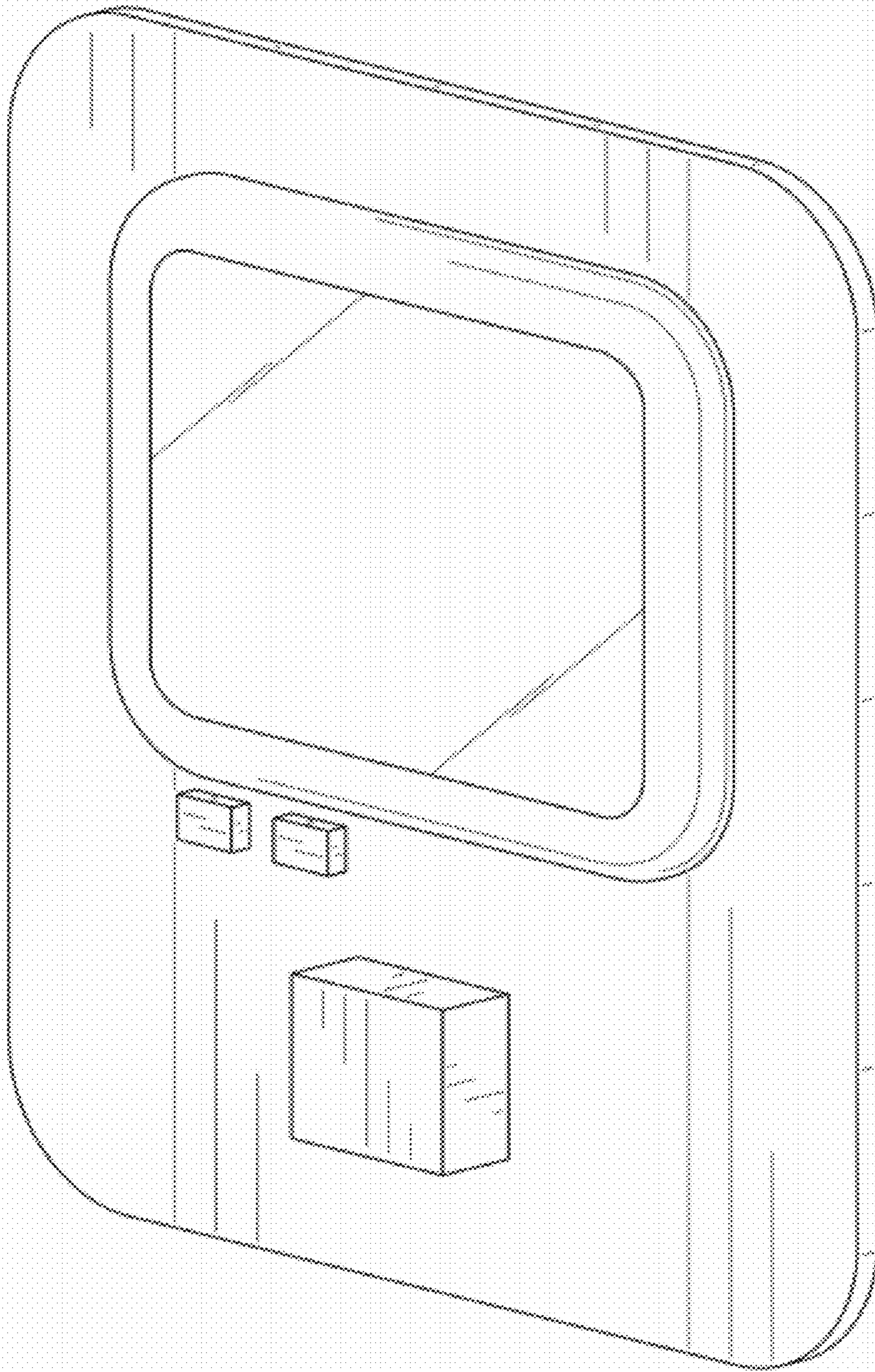


FIG. 1

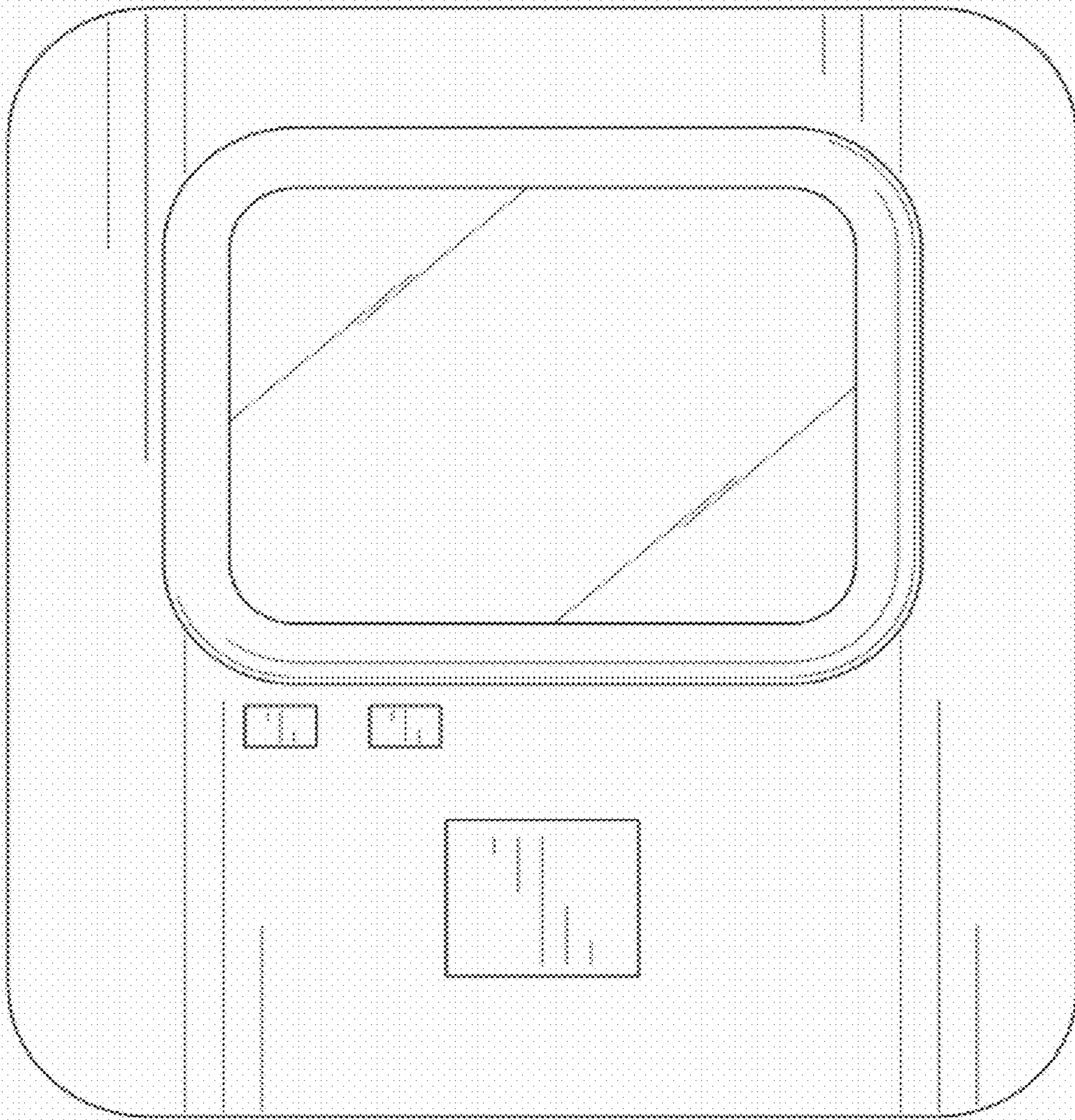


FIG. 2

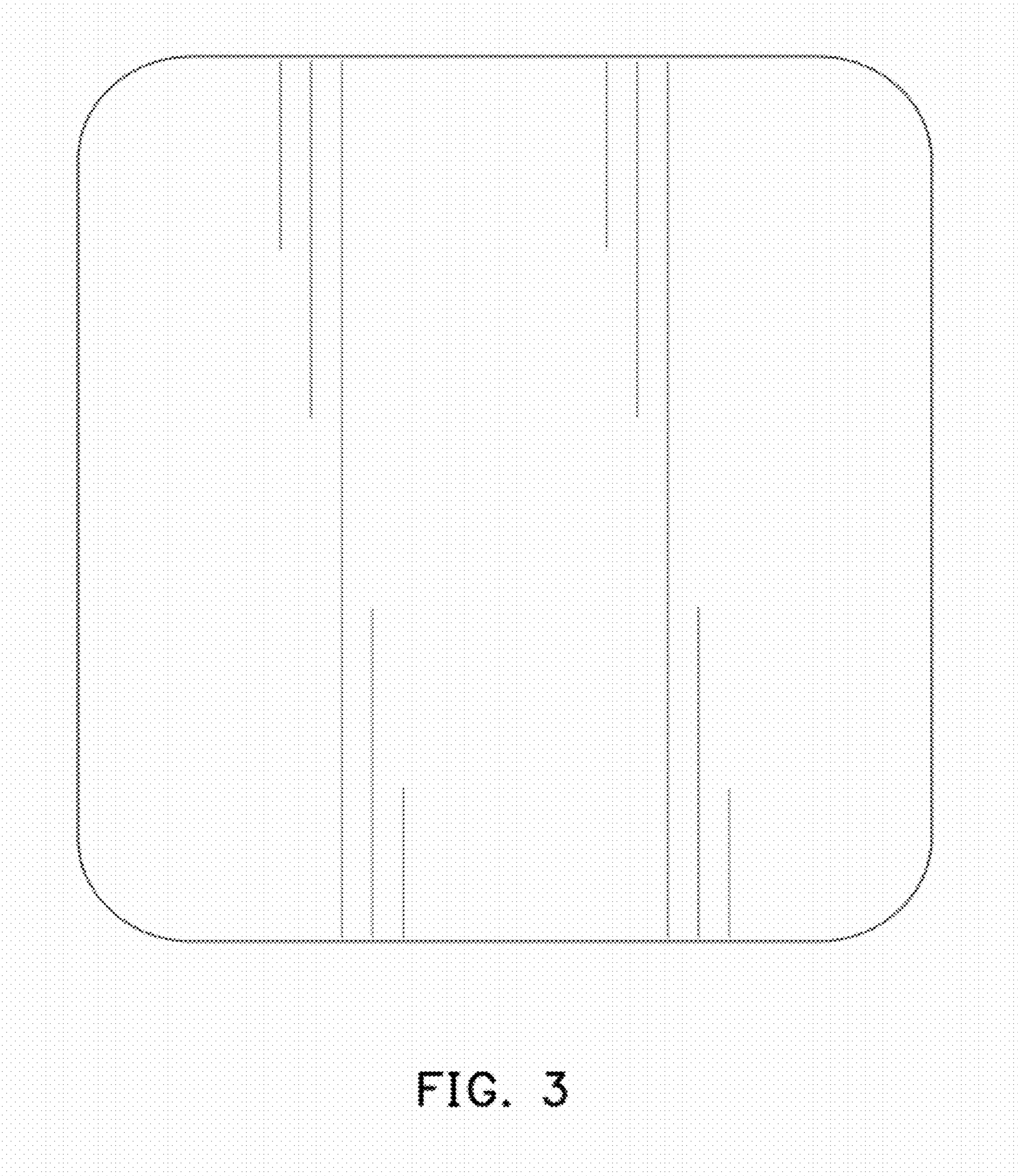


FIG. 3

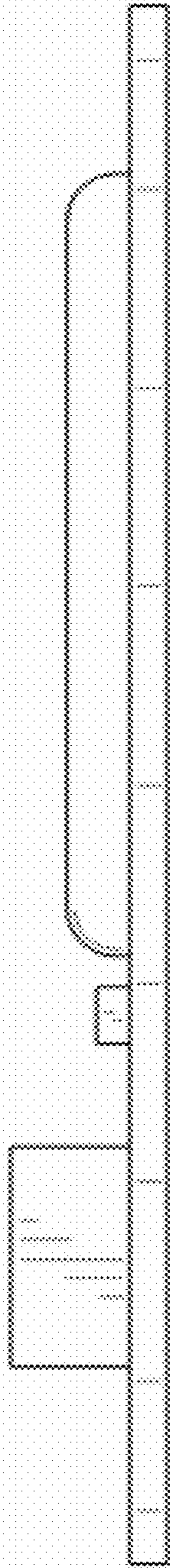


FIG. 4

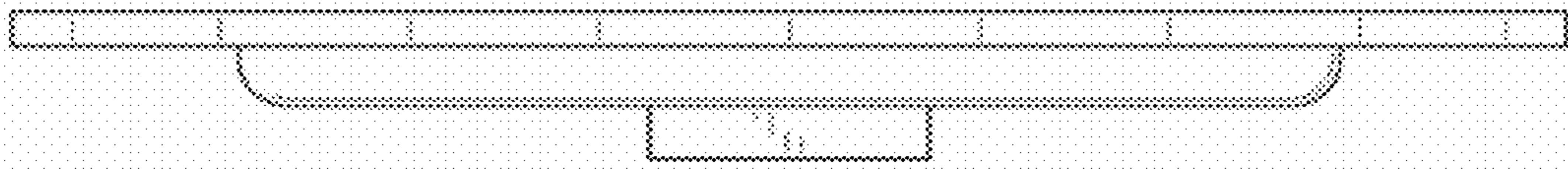


FIG. 5

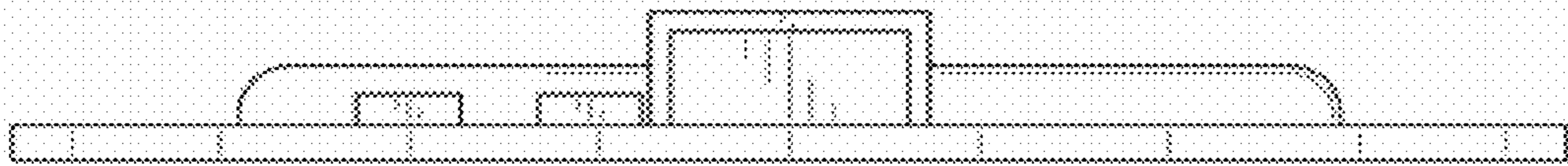


FIG. 6

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : D665,519 S
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DATED : August 14, 2012
INVENTOR(S) : Tsuyoshi Oyaizu

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It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the title page of the patent grant, please replace In item (73) Assignee's residence country from 'Taiwan' to --Japan--

Signed and Sealed this
Fourteenth Day of May, 2013



Teresa Stanek Rea
Acting Director of the United States Patent and Trademark Office